

Connecting Xilinx FPGAs to Texas Instruments ADS527x Series ADCs

Author: Marc Defossez

Summary

This application note describes how to connect a high-speed Texas Instruments (TI) ADS5273 analog-to-digital converter (ADC) with serialized LVDS output to a Virtex[™]-II or Virtex-II Pro[™] FPGA. Lower speed ADC devices from this family can be connected to Spartan[™]-3 FPGAs.

Introduction

Texas Instruments has an 8-channel, 12-bit ADC family with synchronous LVDS outputs. The performance rates of these ADCs range from 40 MSPS to 70 MSPS. This family fits nicely with the LVDS I/Os of the Virtex-II, Virtex-II Pro, and Spartan-3 devices.

To highlight the performance of both the ADC and the FPGA, the reference design described in this application note uses the ADS5273, which is the highest speed sampling ADC. The ADS5273 interfaces to an XC2V250-6FG256 device (to fit the Texas Instruments demo board) and to an XC2VP20-6FF896 device (to fit Xilinx demo boards).

ADS527x ADCs

The ADS527x components are 8-channel, 12-bit analog-to-digital converters with serialized LVDS interfaces and sample rates from 40 MSPS to 70 MSPS. This section summarizes their features and applications. For complete information, refer to the TI website at:

http://focus.ti.com/analog/docs/analoghomepage.jsp?templateId=1&familyId=2&navigationId=9628

Features

The key features of the ADS527x family are:

- Maximum sample rate of 40 MSPS (ADS5279), 50 MSPS (ADS5271), 65 MSPS (ADS5272), and 70 MSPS (ADS5273)
- 12-bit resolution
- · No missing codes
- Power dissipation of 1.1W
- CMOS technology
- · Simultaneous sample and hold
- 70.5 dB signal-to-noise ratio (SNR) on a 10 MHz interface
- Serialized LVDS outputs meet or exceed the requirements of the ANSI TIA/EIA-644-A standard
- Internal and external references
- 3.3V digital/analog supply
- TQFP-80 PowerPAD package

© 2004 Xilinx, Inc. All rights reserved. All Xilinx trademarks, registered trademarks, patents, and further disclaimers are as listed at http://www.xilinx.com/legal.htm. All other trademarks and registered trademarks are the property of their respective owners. All specifications are subject to change without notice.

NOTICE OF DISCLAIMER: Xilinx is providing this design, code, or information "as is." By providing the design, code, or information as one possible implementation of this feature, application, or standard, Xilinx makes no representation that this implementation is free from any claims of infringement. You are responsible for obtaining any rights you may require for your implementation. Xilinx expressly disclaims any warranty whatsoever with respect to the adequacy of the implementation, including but not limited to any warranties or representations that this implementation is free from claims of infringement and any implied warranties of merchantability or fitness for a particular purpose.



Applications

The ADS527x ADC family is intended to be used in the following applications:

- Medical equipment
- Ultrasound systems
- Tape drives
- Test equipment
- Communications
- Optical networking

Implementation Description

Eight differential inputs are sampled at a 70 MHz clock rate. The eight ADC channels can use either an internal or an external reference. Use the internal reference for simplified design and best results.

The ADC has eight LVDS outputs, each one providing a serial 12-bit data bitstream with either MSB or LSB first. An LVDS high-speed clock output (LCLK) and an LVDS delayed repowered sampling clock (ADCLK) are also provided.

The high-speed bit clock, LCLK, is six times the ADCLK sampling clock.

Figure 1 shows the relationship between the different clocks and the output data.

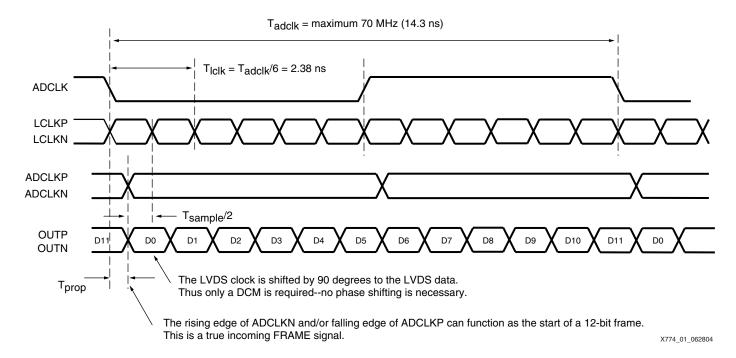


Figure 1: LVDS Timing Diagram (One Channel)

A set of ADC registers can be read or written through an SPI/Microwire (I²C look-alike) protocol. Figure 2 shows the timing of the SPI/Microwire interface. Table 1 defines the parameters listed in the figure.



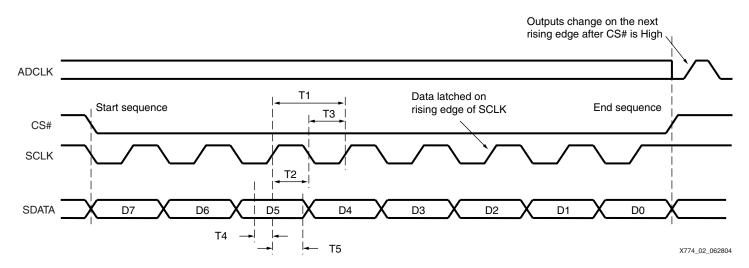


Figure 2: SPI/Microwire Interface Timing Waveforms

Table 1: Microwire Interface Timing Parameters

| Parameter | Description | Minimum | Units |
|-----------|------------------|---------|-------|
| T1 | SCLK Period | 50 | ns |
| T2 | SCLK High Time | 13 | ns |
| Т3 | SCLK Low Time | 13 | ns |
| T4 | SDATA Setup Time | 5 | ns |
| T5 | SDATA Hold Time | 5 | ns |

The SPI/Microwire protocol and it FPGA implementation are not discussed in this application note. Free, adaptable designs can be located on the Internet. For example, search for "SPI core" at http://www.opencores.org to find sample designs.

Single-Channel Interface

For a single-channel design, the ADC specifications are:

- 70 MSPS (equal to 70 MHz)
 - ♦ ADCLK = 70 MHz (14.29 ns)
 - LCLK = 420 MHz (2.38 ns)
- 12-bit serial LVDS interface
- LVDS used in dual data rate (DDR) mode

DDR mode means that the bits are clocked at the FPGA at 840 Mbps.

The FPGA can receive LVDS data streams at that specified speed without problems when the interface design is carefully constructed. This reference design uses an interface design similar to that in telecom data communication LVDS applications.

The ADS527x transmits edge-aligned data and sync signals with a 90-degree shifted clock. Taking into account the PCB layout, data, sync, and clock arrive at the FPGA pins shifted by 90 degrees.

To register the received data into the FPGA with the receive clock, a digital clock manager (DCM) can be used in fixed phase shift mode.



If doubt exists on the data-to-clock alignment, a DCM can be used in dynamic phase shift mode. DCM phase shifting is discussed in "Auto Phase Shift DCM."

Note: When the "Auto Phase Shift" design approach is used, a fixed shift parameter must be applied to the shift operation state machine to keep the 90-degree phase shift between data and clock.

Figure 3 shows a one-channel receiver module. This module takes in the serial differential data of one channel and outputs it, internal to the FPGA, as 12-bit parallel data. This module is used eight times for an 8-channel ADC device.

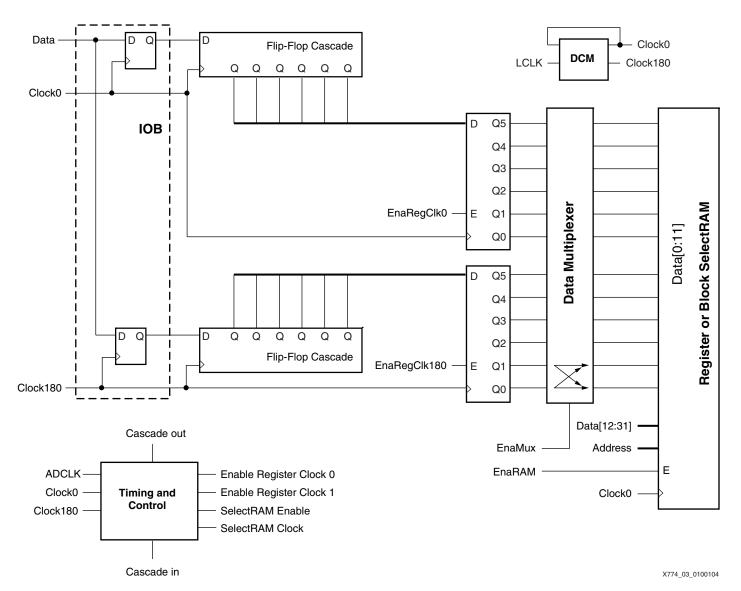


Figure 3: 12-bit Single-Channel Receiver

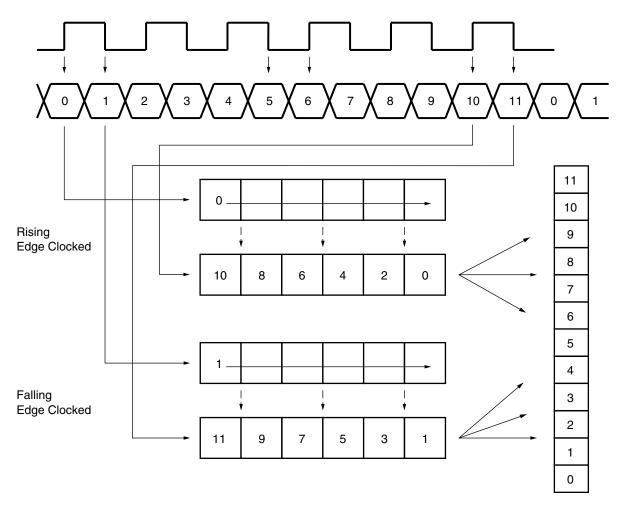
For the single-channel design, the received clock is input to a DCM. This DCM aligns the internal clock to the external applied clock or phase shift the internal clock to the received clock. At the FPGA, the presented data is registered at the right moment, in the middle of the valid data range.

Data is presented in DDR format, meaning that it must be clocked into the receiver registers on the rising and falling edges of the receiver clock. Therefore the clock and 180-degree outputs of the DCM are used. Now the rising edge of both clocks can be used at the flip-flops.

The 12 incoming serial data bits of one channel are split into two sections. The even bits are clocked on the DCM clock, and the odd bits are clocked on the 180-degree shifted clock. At a



strobe pulse, ADCLK, these serial registered bits are stored in a parallel register. The result is a 12-bit parallel word with a jumbled data bit order. For ADCLK and strobe pulse generation, refer to "Single-Channel Interface Timing."



Even numbers are clocked on the rising edge and are positive-edge enabled. Odd numbers are clocked on the falling edge and are negative-edge enabled.

X774_09_070804

Figure 4: Serial Receiver Bit Ordering

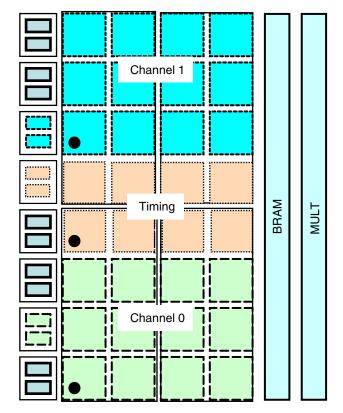
After the bit ordering is resolved in the FPGA routing, this 12-bit word can be used as-is by a back-end application or can be fed to a set of registers, a Block SelectRAM™ FIFO, or a Block SelectRAM memory used as a register. When the 12-bit word is used as-is, the back-end application must run at a clock in phase with the received ADCLK clock, which is not simple to do because this clock is used as a sync (frame) input of the LVDS interface. An easier solution is to let the back-end FPGA design run at a clock rate similar, but not referenced, to the sampling clock and use a FIFO to cross the clock domains between the ADC receiver interface and the application logic. Example designs of both options are included in the reference design.

The receiver module, consisting of two data receive channels and one timing block, is built as a macro containing relationally placed macro (RPM) directives. The reference design provides placement of attributes in the design source code, a user constraint file (UCF), and additional information for placement in different I/O banks of the FPGA.



Note: A timing block takes the sync (frame) signal or a previous RPM timing output and generates the necessary signals for enabling the receiver parallel register and the back-end design stage.

Figure 5 shows the first instance of a dual-channel block in the FPGA.



The black dots are the RLOC_ORIGIN points.

RLOC_ORIGIN Timer is X0Y3.

RLOC_ORIGIN Receiver Channel 1 is X0Y5.

RLOC_ORIGIN Receiver Channel 0 is X0Y0.

X774_04_100104

Figure 5: RPM Dual Channel and Timing Block

All clocked elements of the data receiving and timing modules are RLOC'ed in the module. The three modules are then RLOC'ed with respect to each other. These operations are done, with a set of attributes, in the HDL source code. Rearranging the data receiving and timing modules is now easy. Each module can be rearranged while keeping its shape, making it easy to use the design in single-channel applications.

Single-Channel Interface Timing

The high-speed LCLK is used as an interface clock and is therefore fed into a DCM. This DCM generates two phase-aligned clocks, CLK0 and CLK180.

The data-aligned LVDS version of the ADCLK sample clock is used as a strobe signal to align the captured 12-bit words. The strobe signal is sampled on the positive and negative edges of the high-speed LCLK. Edge detection and phase detection are performed. When a rising edge of ADCLK is detected, two signals are generated to enable the parallel storage registers for the positive and negative clocked data.

Normally, even bits (0, 2, ..., 10) are clocked on the rising edge of CLK0, while odd bits (1, 3, ..., 11) are clocked on the rising edge of CLK180. However, it is possible for the CLK180 edge to arrive first and clock the even data in the odd data shift register. The same then



happens for CLK0. The result is a mangled data word stored in the parallel register. Figure 6 and Figure 7 show the even bits clocked with CLK0 and CLK180, respectively.

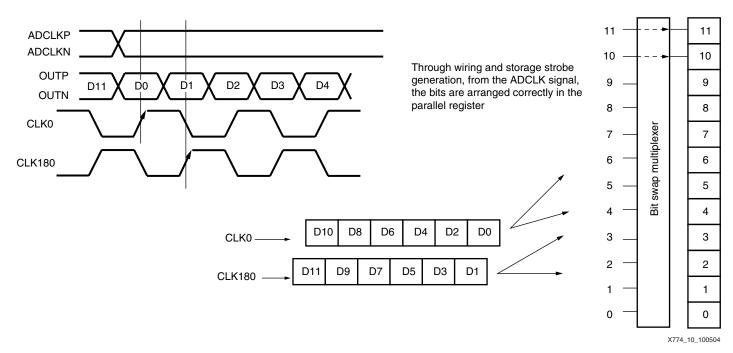


Figure 6: Even Bits Clocked with CLK0

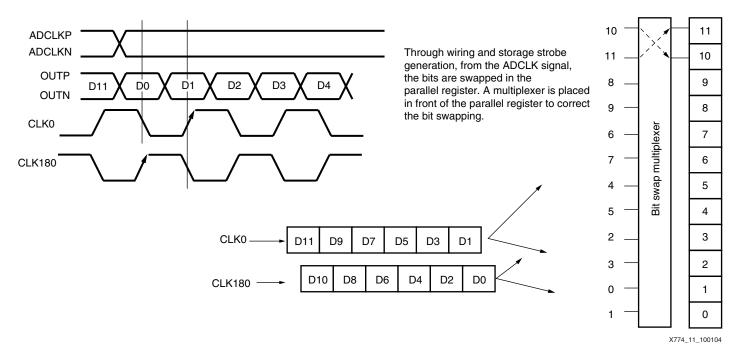


Figure 7: Even Bits Clocked with CLK180

To automatically prevent this bit swapping, a small multiplexer is placed between the parallel latch register and the storage register or Block SelectRAM (FIFO). When the negative frame edge of CLK0 comes before CLK180, negative frame edge data is passed as-is to the parallel register. When the negative frame edge is first detected with CLK180, data is normally bit-swapped when loaded in the storage register or FIFO. However, data is now arranged correctly through the multiplexer.



Auto Phase Shift DCM

The data, sync, and clock signals are shifted 90 degrees (see Figure 1) when the ADC device transmits them to the FPGA interface. Although data and clock traces in the PCB layout are recommended to have the same length to preserve the original phase shift up to the FPGA, it is possible that this phase relationship is distorted.

The phase shift capability of the DCM can be used to position the received LVDS clock exactly in the middle of the received data bit width. The principle of this design is described in XAPP268 (see Reference Item 2, page 16).

In the Virtex-II, Virtex-II Pro, and Spartan-3 device families, all Input/Output blocks (IOBs) are the same except those used as clock inputs. Each of these IOBs has an extra direct input to the DCM clock input. When these IOBs are used as clock inputs, the normal IOB logic is omitted but can be used. This functionality is used by the reference design.

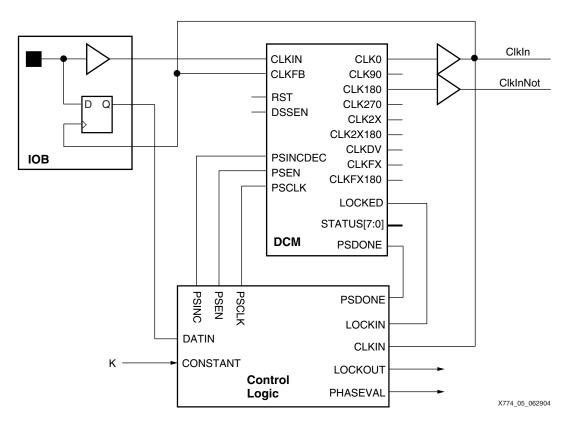


Figure 8: Auto Phase Shift DCM Circuit

In the circuit shown in Figure 8, the incoming clock is used as the clock input and the data input for the IOB flip-flop. The input clock registers itself at the IOB flip-flop with the DCM-adjusted clock (CLK0). The DCM is set in variable mode with an initial phase shift of –255. The equivalent counter in the control logic is set to zero as is the internal state machine. When taken out of reset, the DCM adjusts its output clocks and indicates this process with the LOCKED output (see Figure 9).

8

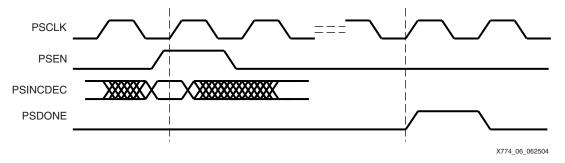


Figure 9: Phase-Shift DCM Interface Timing

Next the DCM is incremented by one with the control logic. The control logic counter is incremented by the PSDONE signal from the DCM. When this operation happens, the output of the IOB flip-flop is checked. When the output is "0", the DCM is again incremented. Then the current counter value is stored (ps0), and the state machine jumps to state one.

Incrementing continues until the input flip-flop changes back to "0". The counter value at this point is also stored (ps1). Next the value ps3 (equal to ps1 - ps0) is calculated. The DCM is now decremented until its value is ps3.

Setup is finished. The LOCKOUT output of the control logic is driven High, which performs the same function as the LOCKED output of the DCM, indicating the startup of the DCM is finished.

When doing using auto-phase shift correction without precautions, the initial 90-degree phase shift might be lost. The DCM moves the clock edge (after adjustment by the control logic) in the middle of a half clock period, reducing the phase shift between clock and data to zero. The fixed value K must be applied to the state machine to be sure a phase shift of 90 degrees is established. The value K is a constant applied in the HDL code.

FIFO and Data Storage Extension

When the basic reference design is used as provided, once the parallelized 12-bit values are clocked in a single register, they must be taken immediately by the back-end application design. This design must function at a clock synchronous to ADCLK.

Another approach is to store received parallel data in a FIFO and read it out with the back-end application design. In this case, it is possible to run the back-end design at an unrelated but frequency-similar clock. The FIFO is used to bridge the two clock domains.

As in telecom applications, ADC converters produce a continuous stream of data, resulting in a continuous stream of parallel 12-bit words. The FIFO that best fits this application is called a self-addressing FIFO.

FIFOs are constructed from memory, read counters (pop), write counters (push), and flagging logic. With a self-addressing FIFO, the counters are replaced by the memory itself and clock skew is no longer an issue.

Figure 10 shows a standard self-addressing FIFO as described in XAPP291 (see Reference Item 3, page 16). Part of the memory data output is fed back as memory address.



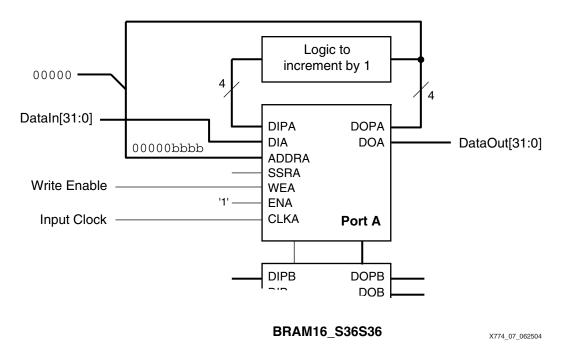


Figure 10: Standard Self-Addressing FIFO

At the start of operation, the memory output is assumed to be all zeros. The RAM is addressed with this value from the feedback part of the output. At the same time, the data is incremented (in the LUT adder) by one, and the result is presented at the memory data input together with the incoming data.

The next clock edge addresses memory space "zero" and writes the data value "zero+1 & input data". Due to the construction of the memory blocks, this value appears at the output after a Clock-to-output (Tbcko) time. Now memory space "one" is addressed and a data value of two (output one + added one) is presented at the input.

The address increment logic is built from a LUT and does not require a clock. Addition of a clock loses the advantage of direct data out.

Block SelectRAM memories have an ideal design for this mechanism. When a 32-bit wide FIFO is needed, the extra four bits (parity bits) can be used for the address storage-incrementer functionality.

A 16-deep FIFO can be constructed using four bits (the parity RAM bits). If a deeper FIFO is needed, the following solutions are possible:

- Use normal data bits as adder / counter bits
 This solution limits the width of the input data. One block RAM is used per two ADC channels (2*12 bits), using 24 bits and leaving 8 bits as counter / adder storage bits.
- Use an extra adder

This solution extends the address with the extra adder. When the address reaches the maximum value available in memory, the result is incremented by one. The extra adder does not need to run at full FIFO speed, but the increment to the BRAM timing must be controlled.

Figure 11 shows an address-extended self-addressing FIFO.

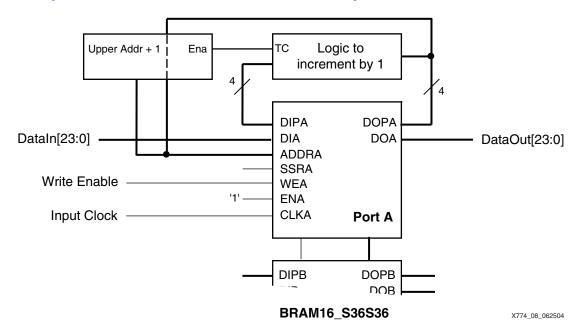


Figure 11: Address-Extended Self-Addressing FIFO

PCB Guidelines

This section alerts the PCB designer to several PCB layout issues. Remember that PCB design is not just putting traces on a piece of hard material in order to make electronic components do something meaningful.

Component Placement

Try to place the different circuit components as close as possible to each other and line them up with regard to the I/O pinning. Position the components so that PCB traces do not take a lot of turns, corners, and pass through PCB vias when going from one component to another.

The FPGA is flexible to pin-locking with regard to the internal FPGA design.

A straight, short connection improves all possible parameters of a PCB layout:

- Signal integrity
- Transmission line effects
- Capacitance and inductance
- · Operating frequency

When distances between components are long, transmission line effects matter. Make sure that all transmission lines are terminated properly to control reflections.

Before starting a PCB layout, determine the number of layers to be used. Decide also the destination of the layers (signal, ground, power, and so forth).

It is best to take an extra day with the layout software to shuffle the components on your PCB and find a good placement, rather than risk ending up with a bad PCB design.

Component Placement Examples

The data/frame receiver in the FPGA has been RLOC'ed between the IOB and the first Block SelectRAM column in the FPGA. One module contains two data inputs and one framing/timing input (Figure 12).

This makes it possible to lock I/O pins in a range of six possibilities (Four I/Os in front of the receiver block, one I/O up, and one I/O down).

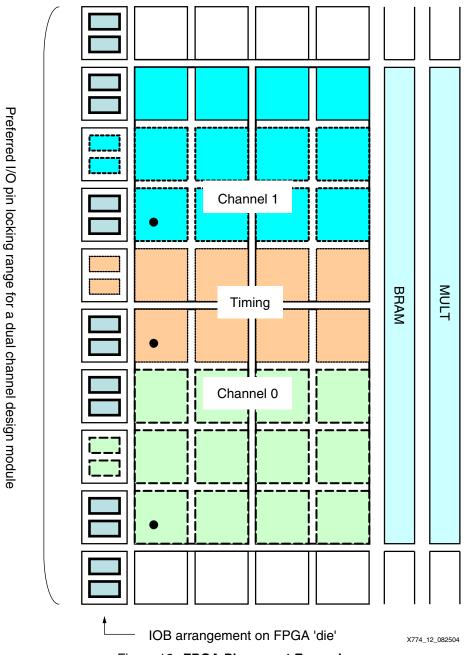


Figure 12: FPGA Placement Example

Figure 13 shows a possible connection between the ADS527x device and a Virtex-II or Virtex-II Pro FPGA.



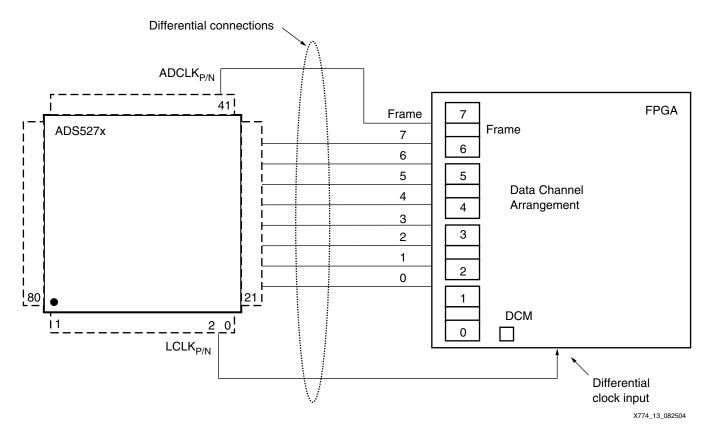


Figure 13: Connection between an ADS527x and FPGA

Make sure all Low Voltage Differential Signaling (LVDS) transmission lines have the same length! It is recommended that the clock and data signals have the same length. The DCM in the Virtex-II or Virtex-II Pro FPGA can provide help positioning the clock to the data when used in Phase Shift mode.

Guidelines and Recommendations

The following bulleted list summarizes key guidelines for PCB designs:

- Spend sufficient time when placing components for layout. With today's layout tools, this is like a shuffling block game.
- Keep the trace lengths as short as possible.
- Spend time determining the number of PCB layers and how the layer stack-up is realized.
- If possible during PCB layout, keep the length of a track shorter than the travel and reflection time of the signal on the trace. If not possible, take the transmission line theory into account.
- Match the length of all differential traces (data and clock).
- When making turns with these differential traces, turn as many times to the left as to the
 right. When making a turn with a differential trace, the inner trace becomes shorter than
 the outer trace of the pair. When using more turns in one direction, one trace of the
 differential pair is longer than the other (without direct correction possibilities).
- Route traces on the PCB as far from each other as possible to avoid or minimize crosstalk effects. Spread traces after routing over the available space of the PCB.
- Do not route traces into 90-degree turns, and avoid routing traces into 180-degree turns (except when you know what you are doing). 90-degree turns increase the effective width of the trace, contributing to parasitic capacitance. At very fast edge rates, these discontinuities can cause significant signal integrity problems.



- Use round, circular turns. If this is not possible, use 45-degree corners.
- Take the guidelines of the signal return paths into account.
- Guard traces.
- Remember the importance of ground planes.
- Specific to the ADS52xx TQFP package: Use the thermal pad connection, called PowerPad, to improve the operating stability of the device.

Reference Design

The reference design uses techniques described in XAPP291, XAPP265, and XAPP268 (see "Reference Material"). The design is set up as a modular block design.

Design Files

A complete functional design is included in the ZIP file with this application note. The reference design files can be downloaded from:

http://www.xilinx.com/bvdocs/appnotes/xapp774.zip

The files refer to the Xilinx demo boards using XC2VP20-6FF896 devices or Texas Instruments demo boards using XC2V250-6FG256 devices.

Note: The BIT file for download of the design is for JTAG use only! The xapp 774.zip file contains readme.txt files in order to make customization of this reference design easy.

Additional design files are provided so that the design can easily be used in other applications and systems. These files include:

- Small and large receive FIFOs
- Auto phase shift DCM
- A UCF file with the parallel data inputs and outputs placed on the same side of the FPGA (in the same I/O bank)
- Simulation files for the reference design and subdesigns



Design Directory Setup

This section provides the directory setup of the reference design files:

```
/AdcTi
 Ads5273IntV2Simple readme.txt -- This readme file.
 /Documents
   ads5273.pdf
                                  -- Texas Instruments ADC datasheet.
   ADS5273 Simple Interface.ppt -- PowerPoint presentation about this design.
   XAPP774.pdf
                                  -- Xilinx Application note. Look on the Xilinx
                                  -- web pages for the latest version.
 /Extra
   Now empty but can contain PCB layout, schematics, etc.
 /Ise
   /FreqGenXlvdsPro
   /Virtex2V2506Fg256
                                  -- Directory for Xilinx tools, simple design.
   /Virtex2VP206FF896
                                 -- Directory for Xilinx tools, full design.
 /SimScripts
   SimReadMe.txt
   RandomNumberGenerator.xls
   /ADS527xEVM_ADSDeSer-50EVM
                                  -- Various simulation scripts for Models use.
                                  -- All files are .do files and can be invoked
                                  -- from within Models.
     Tools --> Execute Macro --> browse to the correct .do file.
 /Simulation
                                  -- Work directory for the simulator.
   /work
 /Synthesis
   SynthReadMe.txt
   /FreqGenXlvdsPro
   /Synplicity
     /Virtex2V2506FG256
                                 -- Synthesis directory of TI eval. design.
     /Virtex2VP206FF896
                                 -- Synthesis directory for XlvdsPro design.
   /Precision
     /Virtex2V2506FG256
                                  -- Synthesis directory of TI eval. design.
     /Virtex2VP206FF896
                                  -- Synthesis directory for XlvdsPro design.
 /Ucf
   UcfReadMe.txt
   Different User Constraint Files for use with ISE tools.
 /Verilog
   Verilog source code
 /Vhdl
   VhdlReadMe.txt
   /ADS527xEVM_ADSDeSer-50EVM
     /AdcReceiver
       AdcReceiver.vhd
       AdcReceiver_TestBench.vhd
       Ads5273_tester.vhd
       Receiver.vhd
       RxTiming.vhd
     /AdsV2SmplNoFifo
                                    -- design for Virtex-II FPGA, no FIFO.
       Ads5273_Tester.vhd
       {\tt GenStuff\_Tester.vhd}
       Toplevel_V2_Smpl_Nff.vhd
       Toplevel_V2_Smpl_Nff_TestBench.vhd
     /DcmPhaseCtrl
       Bcd35FullRange.vhd
       PhaseControlFullRange.vhd
   /XlvdsPro
     /AdcReceiver
       AdcReceiver.vhd
       AdcReceiver_TestBench.vhd
       Ads5273_tester.vhd
       Receiver.vhd
       RxTiming.vhd
     /AdsV2SmplNoFifo
                                    -- design for Virtex-II FPGA, no FIFO.
       Ads5273_Tester.vhd
       GenStuff_Tester.vhd
```



```
Toplevel_V2_Smpl_Nff.vhd
   Toplevel_V2_Smpl_Nff_TestBench.vhd
  /DcmPhaseCtrl
   Bcd35FullRange.vhd
   PhaseControlFullRange.vhd
 /DcmLifeIndicator
   DcmLifeIndicator.vhd
/ExtraSourceCode
 /LargeSelfAddrFifo
   GrayCnt4b.vhd
   LargeSelfAddrFifo.vhd
   LargeSelfAddrFifo_TestBench.vhd
   LargeSelfAddrFifo_Tester.vhd
 /SmallSelfAddrFifo
   SmallSelfAddrFifo.vhd
   SmallSelfAddrFifo_TestBench.vhd
   SmallSelfAddrFifo_Tester.vhd
```

Reference Material

The following documents provide supplementary material useful with this application note:

- 1. Xilinx XAPP265: "High-Speed Data Serialization and Deserialization (840 Mb/s LVDS)"
- 2. Xilinx XAPP268: "Active Phase Alignment"
- 3. Xilinx XAPP291: "Self-Addressing FIFO"
- Xilinx XAPP623: "Power Distribution System (PDS) Design: Using Bypass/Decoupling Capacitors"
- 5. Xilinx XAPP659: "Using 3.3V I/O Guidelines in a Virtex-II Pro Design"
- 6. *RF Circuit Design: Theory and Applications*: Reinhold Ludwig/Pavel Bretchko (Prentice Hall ISBN 0-13-095323-7).
- 7. RFI/EMI/EMC: A Designer's Handbook: Gary A. Breed
- 8. *Microwave Circuit Analysis and Amplifier Design*: Samuel Y. Liao (Prentice Hall ISBN 0-13-586736-3)
- 9. Reference Data for Engineers: Radio, Electronics, Computer, & Communications, Mac E. Van Valkenburg (Newnes)
- 10. *Transmission Lines for Digital and Communications Networks*: Richard E. Matick (McGraw Hill, 1969)
- 11. IPC publications: IPC-2141 and IPC-D-317A, along with corrections and adjustments to these publications from IPC and others
- 12. Radio Handbook, 23rd edition: William I. Orr (Newnes, 1997. ISBN 0-7506-9947-7)
- 13. High-Speed Digital Design: A Handbook of Black Magic, Howard Johnson Martin Graham (Prentice Hall ISBN 0-13-395724-1)
- 14. High-Speed Signal Propagation: Advanced Black Magic, Howard Johnson Martin Graham (Prentice Hall ISBN 0-13-084408-x)

Conclusion

A Xilinx Virtex-II, Virtex-II Pro, or Spartan-3 (lower speed) FPGA easily can be used as an interface to high-speed Texas Instruments ADS527x analog-to-digital converters. The FPGA can be used as a direct data processing unit in high-speed data conversion designs and perform a front-end or back-end application for a DSP, such as the TMS320C64xxx devices. A possible design setup can be: ADC — LVDS FPGA interface — FPGA processing unit — FPGA EMIF interface — DSP.



Revision History

The following table shows the revision history for this document.

| Date | Version | Revision |
|----------|---------|--|
| 07/26/04 | 1.0 | Initial Xilinx release. |
| 11/04/04 | 1.1 | Replaced Figure 3. Added paragraph about RLOC'ing under Figure 5. Rewrote "Single-Channel Interface Timing" and included two new figures (Figure 6 and Figure 7). Added "PCB Guidelines" section. Revised the directory structure in "Design Directory Setup". Added additional documents to "Reference Material". |